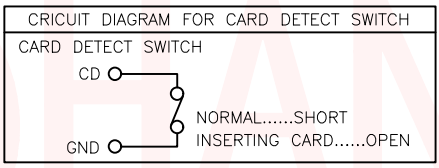
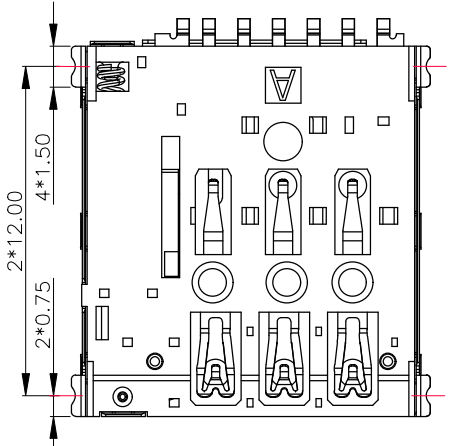
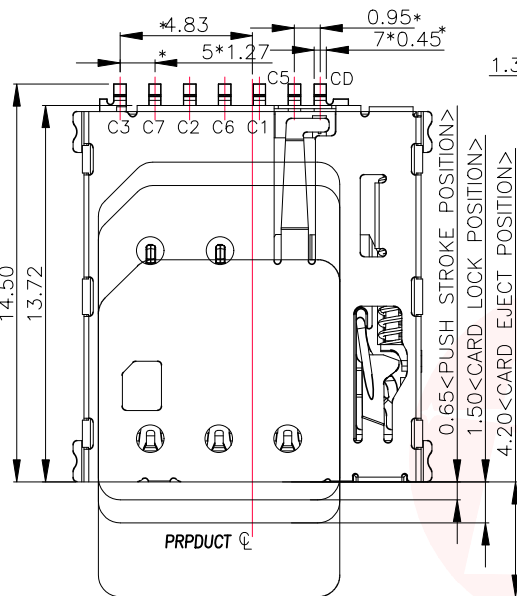
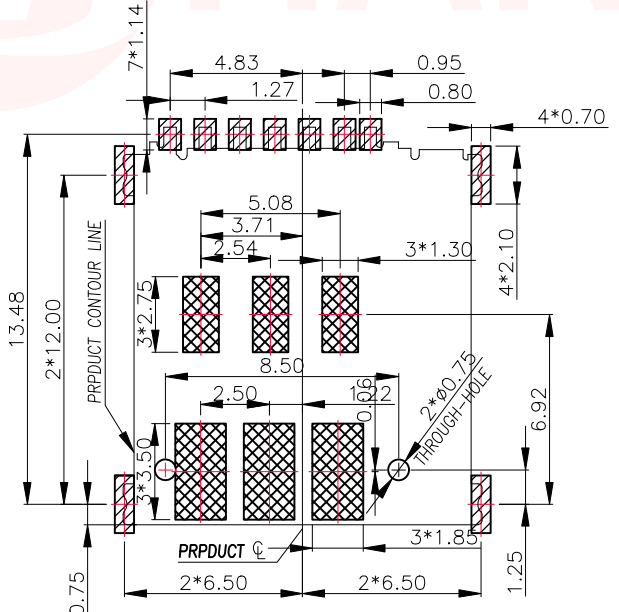
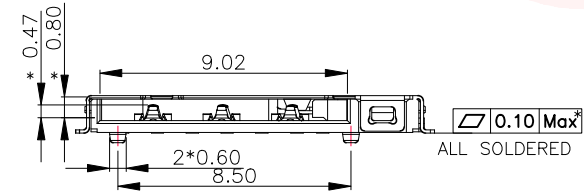




REV.	ECN NO OR DESCRIPTION	REVISED	DATE

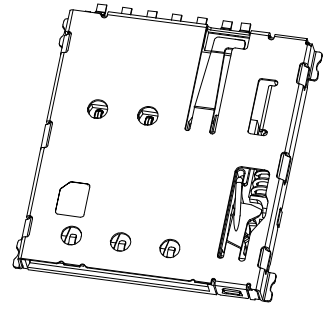


NOTES:  
 1.MATERIAL:  
 HOUSING: High Temperature Thermoplastic  
 Terminal:Copper Alloy  
 Shell: Stainless Steel  
 2.PLATING:  
 Terminal:50u" Ni UNDERPLATED OVERALL  
 G/F PLATED ON CONTACT AREA AND SOLDER AREA  
 Sheel:30u" Ni UNDERPLATED OVERALL  
 G/F PLATED ON CONTACT AREA AND SOLDER AREA  
 3.technical speciality:  
 RATED VOLTAGE: 30V AC MAX.  
 CURRENT RATING: 0.5A MAX.  
 INSULATION RESISTANCE:1000MΩ MIN  
 CONTACT REISTANCE:50mΩ MAX  
 WITHSTANDING VOLTAGE: 500V AC FOR 1 MINUTES  
 OPERATING TEMPERATURE:  
 -25℃~+85℃ Humidity 80% R.H MAX  
 4.DIMENSIONS WITH MARK" \* "MUST BE MEASURE BY QC AND IPQC



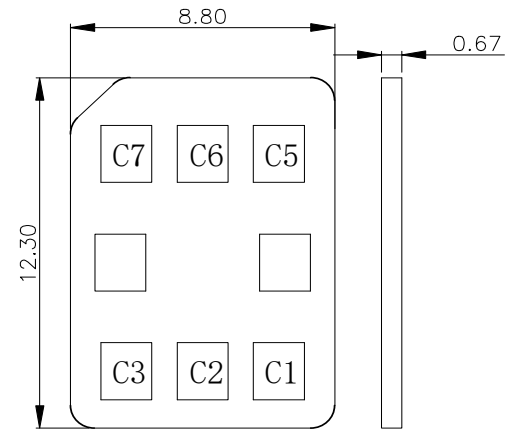
RECOMMENDED PCB LAYOUT TOP VIEW (TOLERANCE:±0.05)  
 RECOMMENDED MATAL MASK T=0.12mm

SMT SOLDER AREA  
 NO PATTERN AND VIA HOLE IN HTIS AREA



3D VIEW

PIIN/NO	ASSIGNMENT
C1	VCC
C2	RST
C3	CLK
CD	Detect Switch
C5	GND
C6	VPP
C7	I/O



UNLESS OTHERWISE SPECIFIED TOLERANCES		东莞市汉博电子科技有限公司 DONGGUAN HANBO TECHNOLOGY CO., LTD		
DECIMALS:	ANGLES:	TITLE	6+1PIN 1.37H NANO SIM CARD CONNECTOR	
X :±0.35	X :±2°	DWN	xiong	PART NO. SNO-1351
X.X :±0.25	X.X :±1°	CHKD	lee	SCALE:1:1 UNIT: mm
X.XX :±0.15		APVD	wang	SIZE: A4 SHEET:1OF 1 REV: A4
CUSTOMER COPY				